



Pizio Connector:
 Center Hole to Center Hole: 198 mils (180mils measured)
 Diameter of Hole: 053mils (020mils measured)

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Designed for Public Release		Mod. Date: 5/29/2014	
Project Title: Piezoelectric Air Flow Sensor			
Number: SAT0020	Rev: E2.0	Sheet Title: TIDA-00250	
SVN Rev: Not in version control	Assembly Variant: Variant name not interpreted		Sheet: 1 of 1
Drawn By: Ian Cathey	File: TIDA-00250_SchDoc		Size: B
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